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MOSFET - Power, Single N-Channel, SO-8FL

30 V, 0.9 mΩ, 303 A NTMFS4C01N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

			,		
Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	30	V	
Gate-to-Source Voltage		V _{GS}	±20	V	
Continuous Drain Current $R_{\theta JC}$ (Notes 1, 3)	Steady	$T_{C} = 25^{\circ}C$	۱ _D	303	A
Power Dissipation $R_{\theta JC}$ (Notes 1, 3)	State	$T_C = 25^{\circ}C$	P _D	134	W
Continuous Drain Current R _{θJA} (Notes 1, 2, 3)	Steady State	T _A = 25°C	Ι _D	47	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2, 3)	Sidle	$T_A = 25^{\circ}C$	PD	3.2	W
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	552	А
Operating Junction and Storage Temperature Range		T _J , T _{stg} –55 to +150		°C	
Source Current (Body Diode)		l _S 110		А	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 35 A)		E _{AS}	862	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

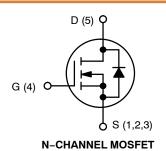
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.93	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

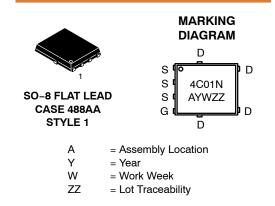
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	0.9 mΩ @ 10 V	000 4
30 V	1.2 mΩ @ 4.5 V	303 A





ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4C01NT1G	SO-8FL (Pb-Free)	1500 / Tape & Reel
NTMFS4C01NT3G	SO–8FL (Pb–Free)	5000 / Tape & Reel

+For information on tape and reel specifications,

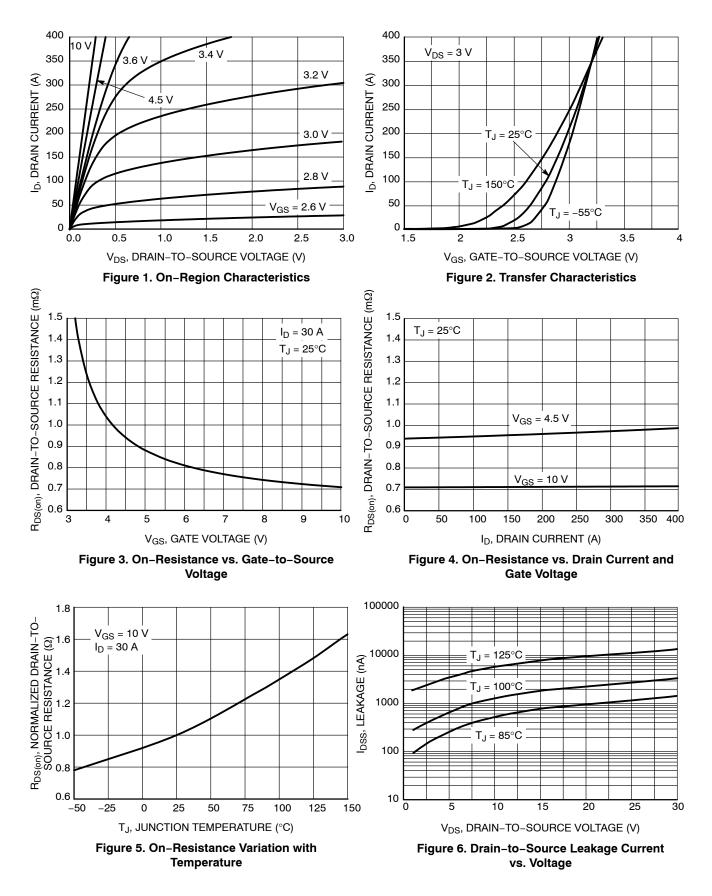
including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

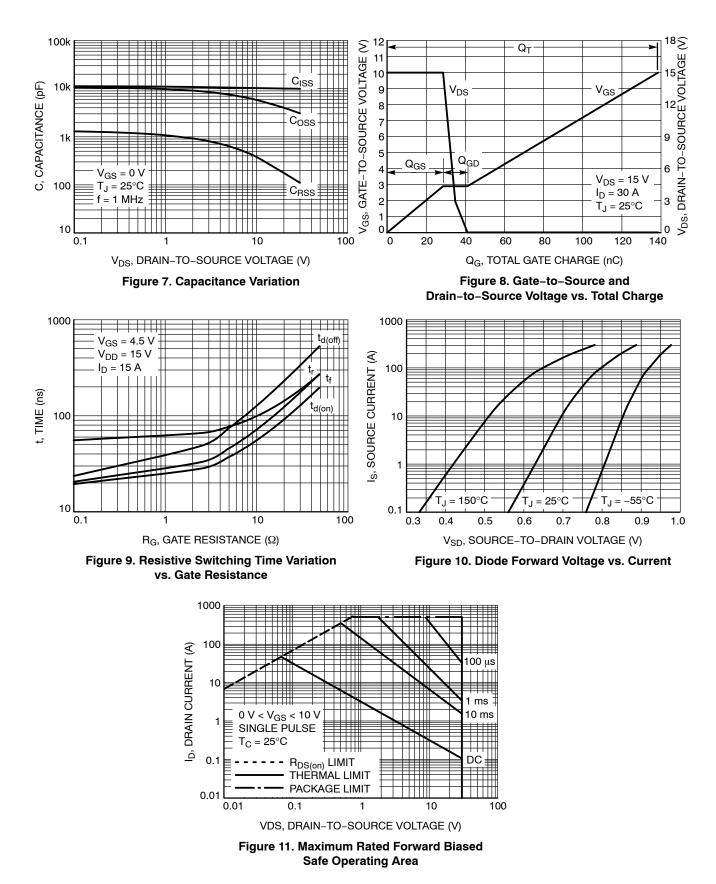
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				16.3		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	T _J = 25 °C			1	μΑ
			T _J = 125°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	e = 250 μA	1.3		2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				5.8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		0.71	0.9	mΩ
		V _{GS} = 4.5 V	I _D = 30 A		0.94	1.2	
Forward Transconductance	9 _{FS}	V _{DS} = 3 V	I _D = 30 A		183		S
Gate Resistance	R _G	T _A = 25 °C			1.0		Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				10144		1
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V			5073		pF
Reverse Transfer Capacitance	C _{RSS}				148		
Total Gate Charge	Q _{G(TOT)}				63		1
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A			18		nC
Gate-to-Source Charge	Q _{GS}				29		
Gate-to-Drain Charge	Q _{GD}				13		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 30 A			139		nC
SWITCHING CHARACTERISTICS (Note 5)							-
Turn-On Delay Time	t _{d(ON)}				29		
Rise Time	tr	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 15 A, R_{G} = 3.0 Ω			68		ns
Turn-Off Delay Time	t _{d(OFF)}				53		
Fall Time	t _f				36		
DRAIN-SOURCE DIODE CHARACTERISTIC	S	•					
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V_{c}$	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$		0.73	1.1	v
		V _{GS} = 0 V, I _S = 10 A	T _J = 125°C		0.55		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 30 A			87		ns
Charge Time	ta				43		
Discharge Time	t _b				44		
Reverse Recovery Charge	Q _{RR}				147		nC

performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \,\mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

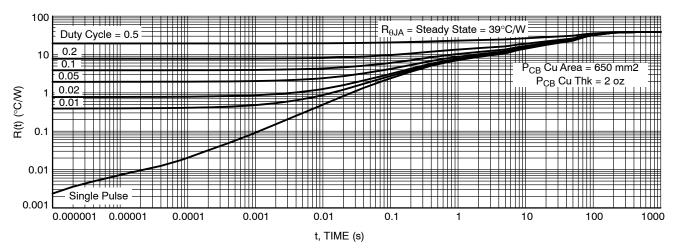
TYPICAL CHARACTERISTICS



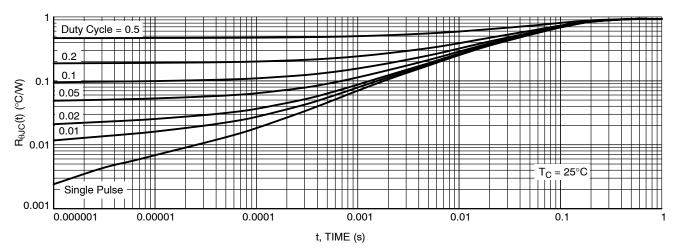
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS









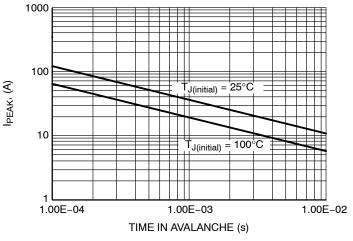


Figure 14. Avalanche Characteristics

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